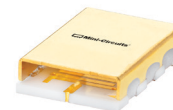


Surface Mount Thin-Film Filters

50Ω DC to 40 GHz

The Big Deal

- Low passband insertion loss
- High rejection
- Good power handling
- Temperature stability -55°C to 125°C
- High repeatability
- RoHS complaint
- Small size



Product Overview

Mini-Circuits' *Surface Mount Thin-Film filters* offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee a enhanced Q and repeatable performance.

Low pass, high pass and bandpass surface mount thin-film designs can be realized with this technology. Using thin-film manufacturing, we can guarantee repeatability on large batches of filters. Thin-film filters are small in size with high-quality, precise machining for applications where size is critical.

Key Features

Feature	Advantages
Low insertion loss	High Q material and sputtering process results in lower insertion loss, better SNR is obtained.
Fast roll-off (steeper skirts)	High selectivity results in better adjacent channel rejection and dynamic range
Wider stopband	Wide spur-free stopband results in better adjacent channel rejection and dynamic range
Temperature stability	Very minimal change in electrical performance across temperature makes these filters suitable for a wide range of operating conditions.
Small Size	Various design techniques are employed to realize small size.

Notes

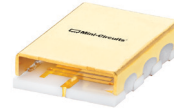
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Surface mount Thin-Film Bandpass Filter

50Ω 6300 to 9200 MHz

ABF-7R75G+



Generic photo used for illustration purposes only

CASE STYLE: UC2731

Features

- Low passband insertion loss of 1.5 dB typical
- High rejection of 50 dB typical
- 20 dB rejection up to 30000 MHz
- Small size

Applications

- 5G
- Wireless communication systems
- Satellite communication
- Military and Defense
- Test and measurement

Electrical Specifications⁽¹⁾ at 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Insertion Loss	F1-F2	6300 - 9200	—	1.5	2.5	dB
	Return Loss	F1-F2	6300 - 9200	—	9.0	—	dB
Stop Band, Lower	Insertion Loss	DC-F3	DC - 3000	40	55	—	dB
		F3-F4	3000 - 4400	20	40	—	dB
Stop Band, Upper	Insertion Loss	F5-F6	11000 - 13000	20	35	—	dB
		F6-F7	13000 - 16000	40	60	—	dB
		F7-F8	16000 - 30000	—	20	—	dB

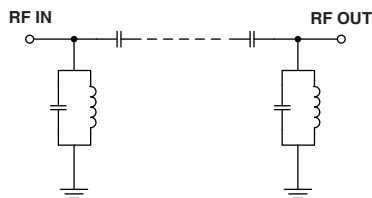
1. Measured on Mini-Circuits Characterization Test Board TB-ABF-7R75G+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

Maximum Ratings

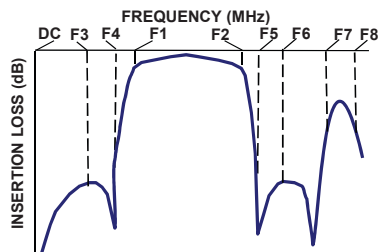
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input	1W Max. @ 25°C

Permanent damage may occur if any of these limits are exceeded.

Functional Schematic



Typical Frequency Response

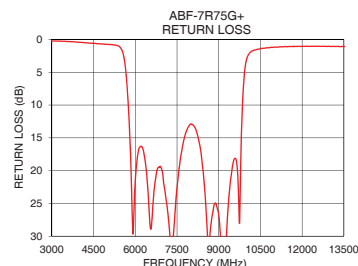
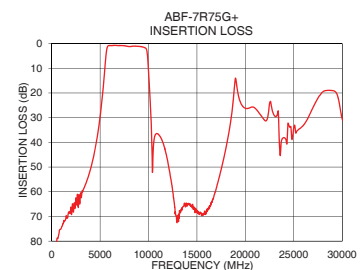
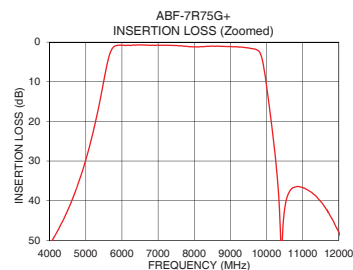


Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	99.40	0.07
500	80.74	0.25
1000	74.70	0.30
3000	60.45	0.22
4400	44.42	0.56
5000	29.73	0.74
5250	20.82	0.83
5650	3.37	4.53
6300	0.76	17.16
6500	0.73	26.41
7750	1.06	15.24
8000	1.21	12.91
9200	1.21	42.18
9950	7.87	4.17
10300	34.43	1.61
11000	36.66	1.18
12000	47.99	1.05
13000	70.62	1.05
16000	67.83	1.27
30000	30.58	2.23

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



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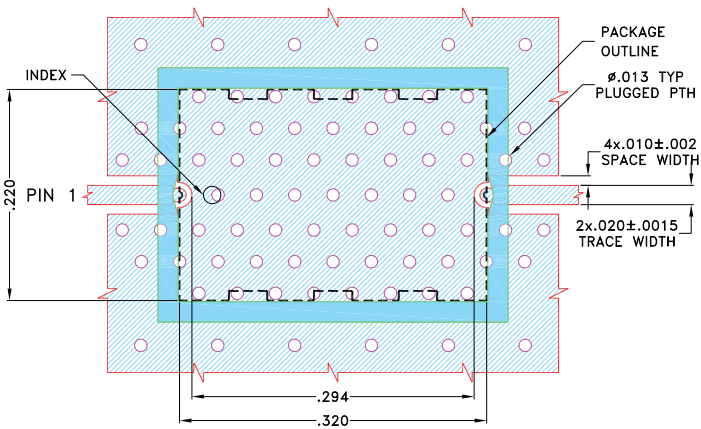
www.minicircuits.com P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 sales@minicircuits.com

REV. C
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Page 2 of 4

Pad Connections

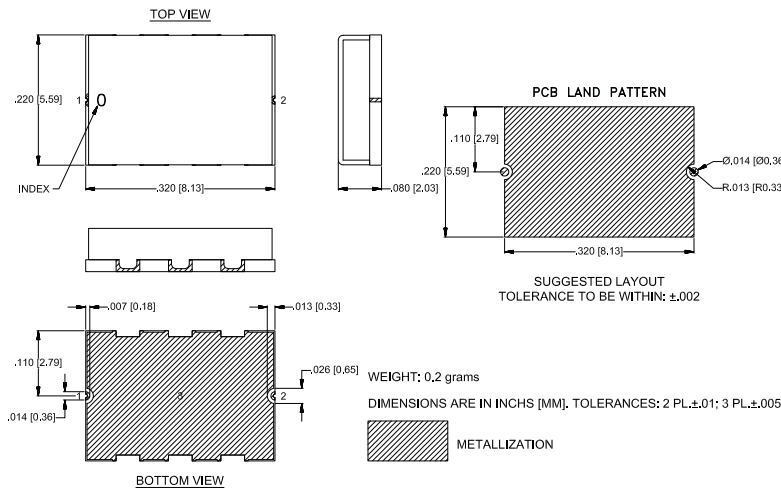
RF IN	1
RF OUT	2
GROUND	3

Demo Board MCL P/N: TB-ABF-7R75G+
Suggested PCB Layout (PL-652)



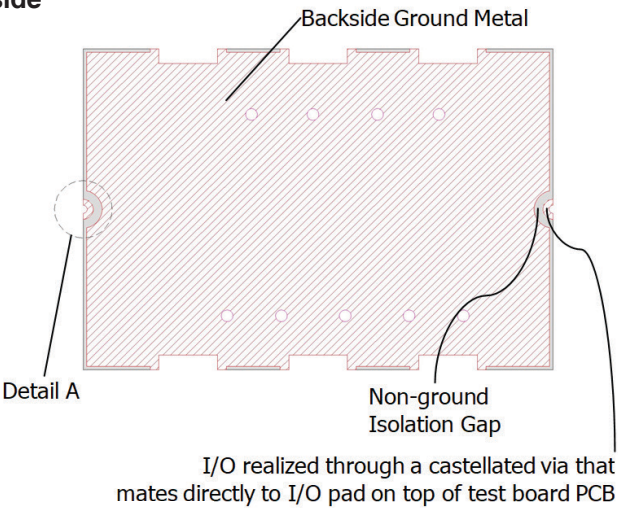
- NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS $.010 \pm .0010$. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
■ DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Outline Drawing



Recommendations of PCB pattern at customer board

Filter Back side



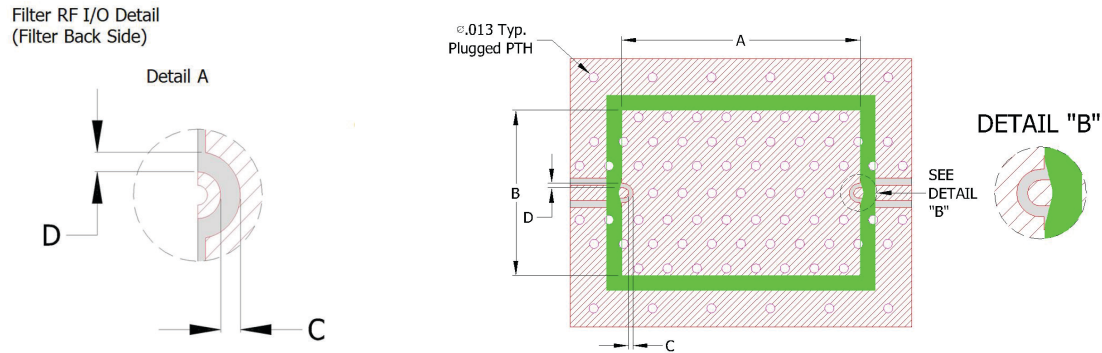
Notes

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PCB Pattern Recommendations

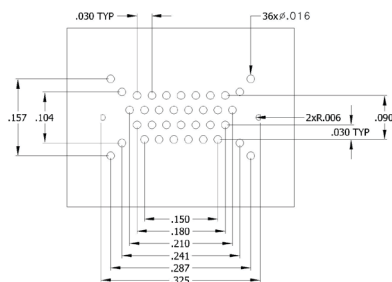


- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
- 5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

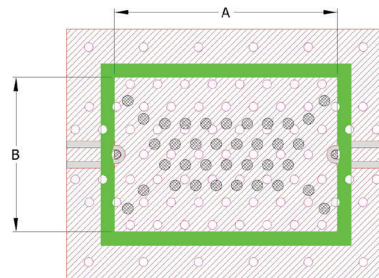
Comments on component handling and solder attach

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

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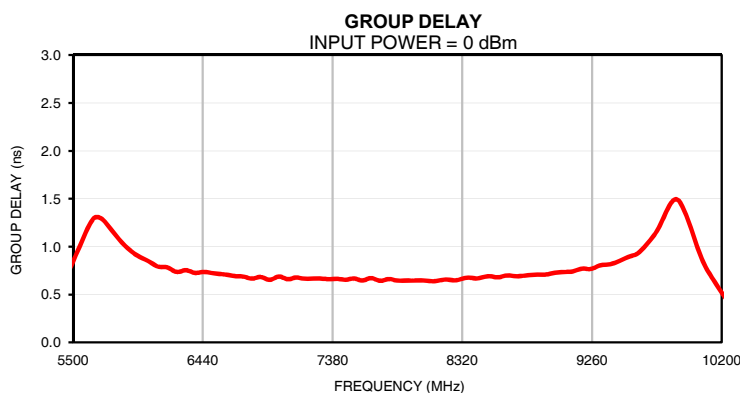
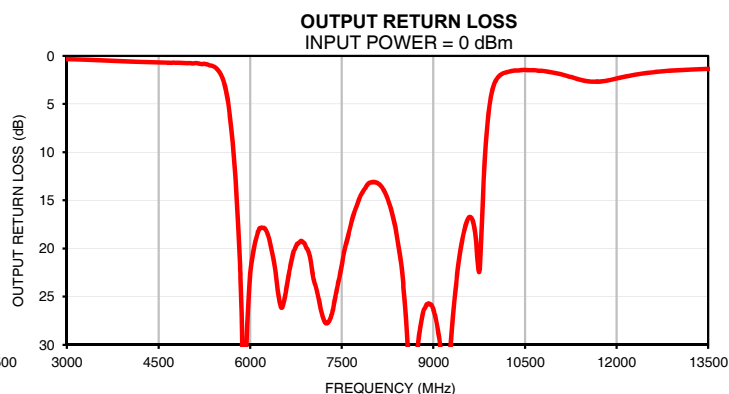
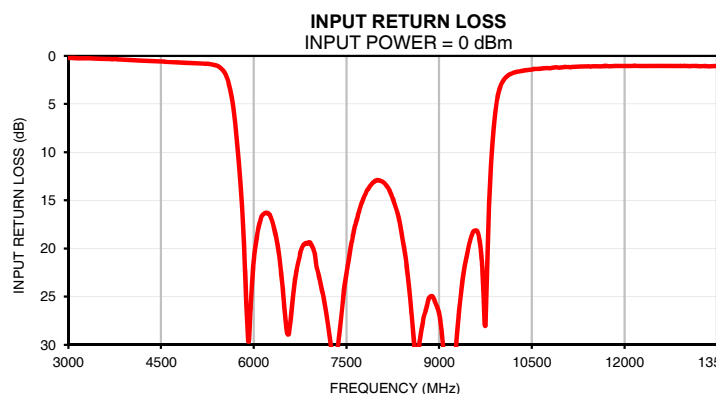
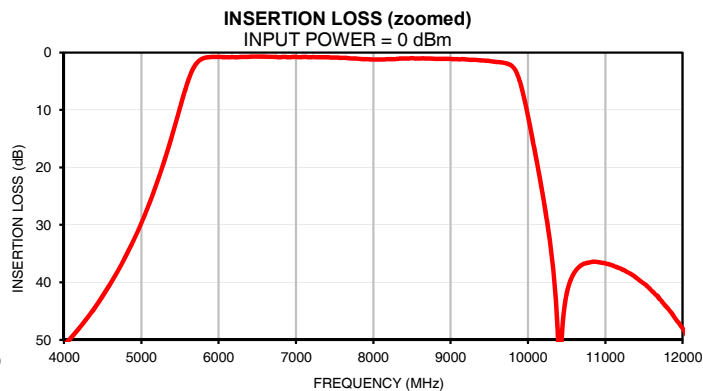


Typical Performance Data

FREQ.	Insertion Loss	Input Return Loss	Output Return Loss
(MHz)	(dB)	(dB)	(dB)
10	99.40	0.07	0.15
50	94.41	0.10	0.18
100	94.15	0.05	0.13
500	80.74	0.25	0.34
1000	74.70	0.30	0.39
2000	66.28	0.27	0.30
2500	62.46	0.21	0.29
2800	61.28	0.21	0.30
3000	60.45	0.22	0.32
3200	60.00	0.25	0.37
3400	57.94	0.27	0.42
3600	55.97	0.31	0.47
3800	53.60	0.38	0.52
4000	50.99	0.42	0.58
4200	47.95	0.50	0.62
4400	44.42	0.56	0.67
4600	40.29	0.64	0.68
4800	35.36	0.69	0.73
5000	29.73	0.74	0.74
5200	22.77	0.81	0.85
5400	14.38	1.00	1.09
6000	0.79	21.36	22.76
6300	0.76	17.16	18.74
6500	0.73	26.41	26.00
7000	0.78	21.12	21.61
7200	0.81	27.77	27.29
7750	1.06	15.24	15.49
8000	1.21	12.91	13.10
8500	1.01	23.19	23.28
9000	1.13	26.75	26.35
9200	1.21	42.18	35.04
9500	1.49	19.18	18.30
9950	7.87	4.17	3.98
10000	11.00	3.04	2.87
10300	34.43	1.61	1.55
11000	36.66	1.18	1.78
11500	40.22	1.09	2.61
12000	47.99	1.05	2.35
12500	59.94	1.04	1.77
13000	70.62	1.05	1.49
13500	66.26	1.06	1.35
14000	64.89	1.11	1.26
14500	66.46	1.14	1.22
15000	67.78	1.19	1.20
15500	69.08	1.25	1.21
16000	67.83	1.27	1.23
16500	64.46	1.28	1.26
17000	58.50	1.29	1.30
17500	51.05	1.33	1.35
18000	42.27	1.41	1.39
18500	31.12	1.63	1.47
19000	14.08	3.59	3.17
19500	23.82	1.80	1.46
20000	26.19	1.90	1.39
20500	25.98	2.69	1.39
21000	26.15	4.97	1.44
21500	28.55	3.82	1.46
25000	34.05	1.68	1.31
28000	19.58	3.68	3.04
30000	30.58	2.23	3.48

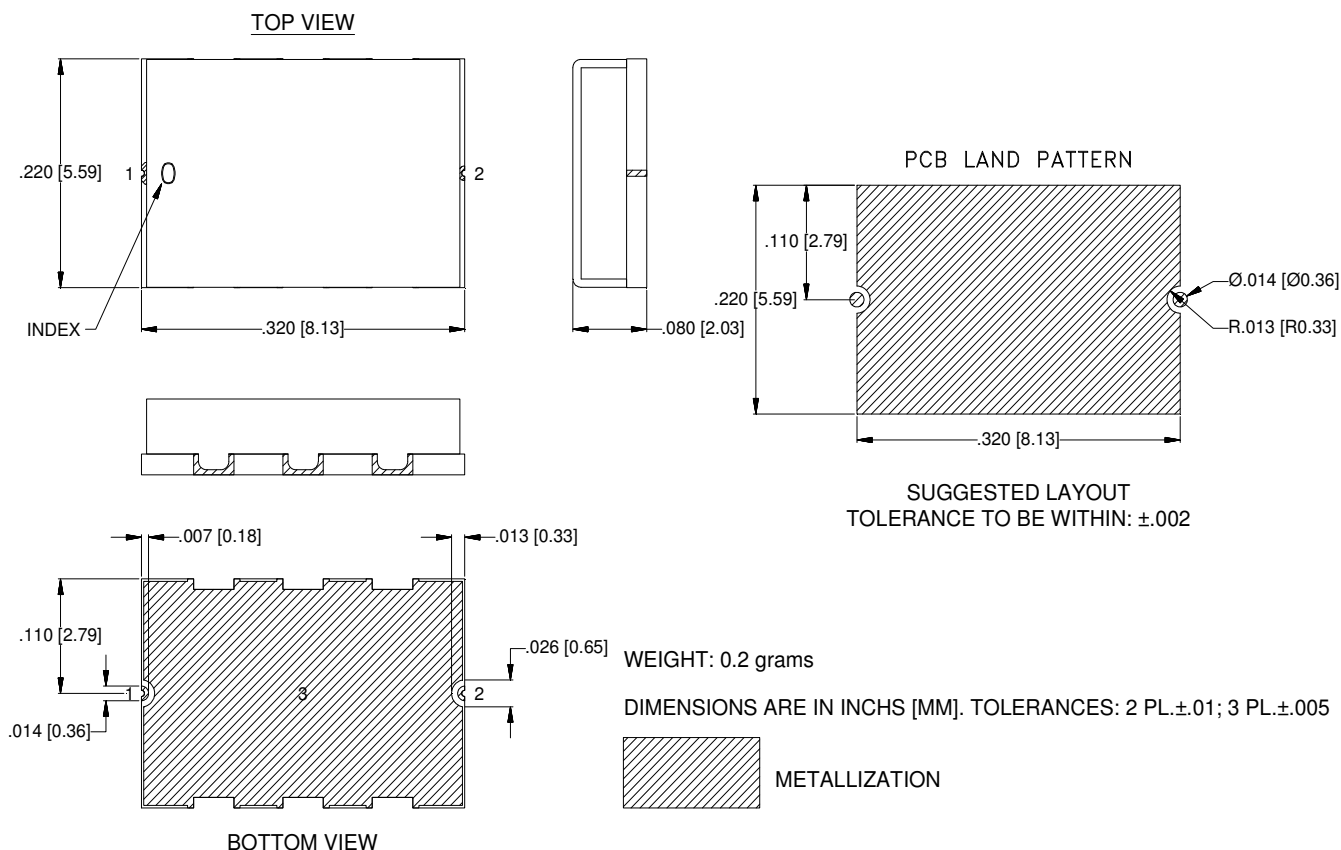
FREQ.	Group Delay
(MHz)	(ns)
6300	0.75
6320	0.76
6340	0.75
6380	0.72
6400	0.72
6450	0.73
6500	0.72
6550	0.71
6600	0.70
6650	0.69
6700	0.69
6750	0.68
6800	0.67
6850	0.68
6900	0.66
6950	0.66
7000	0.68
7050	0.65
7100	0.67
7150	0.67
7200	0.66
7250	0.66
7300	0.66
7350	0.66
7400	0.66
7450	0.66
7500	0.66
7550	0.66
7600	0.64
7650	0.67
7700	0.65
7750	0.64
7800	0.65
7850	0.64
7900	0.64
7950	0.64
8000	0.64
8050	0.64
8100	0.64
8150	0.64
8200	0.66
8250	0.65
8300	0.66
8350	0.67
8400	0.67
8450	0.67
8500	0.69
8550	0.68
8600	0.68
8650	0.70
8700	0.69
8750	0.69
8800	0.70
8850	0.70
8900	0.70
8950	0.71
9000	0.73
9050	0.73
9100	0.73
9200	0.77

Typical Performance Curves



Outline Dimensions

UC2731

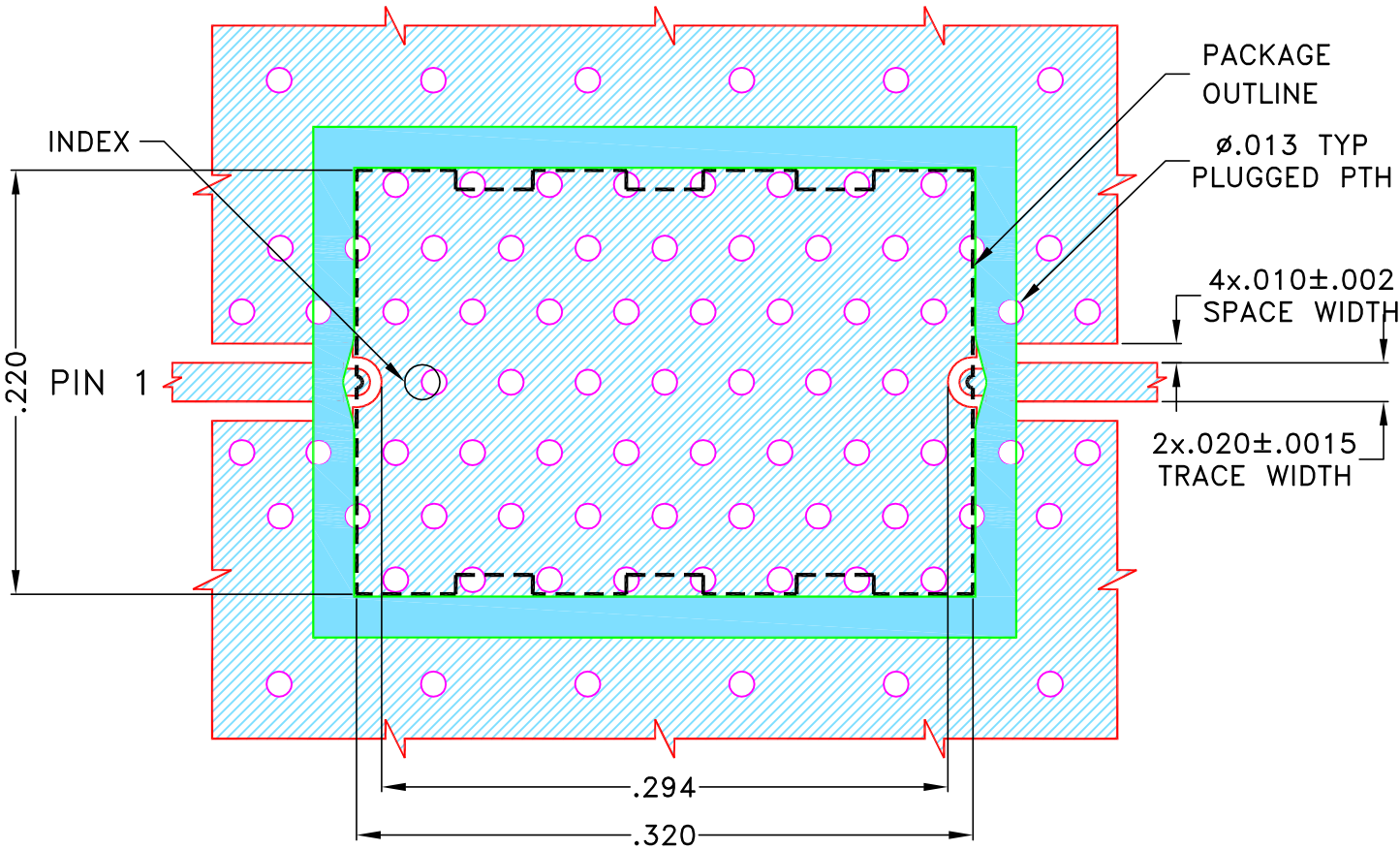




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
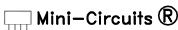
1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.

THIRD ANGLE PROJECTION		REVISIONS				
	REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
	OR	ECO-007104	NEW RELEASE	MAR 21	DDR	VC
	A	ECO-010633	UPDATED AS PER CURRENT TEST BOARD	NOV 21	DDR	VC

SUGGESTED MOUNTING CONFIGURATION
FOR UC2731 CASE STYLE

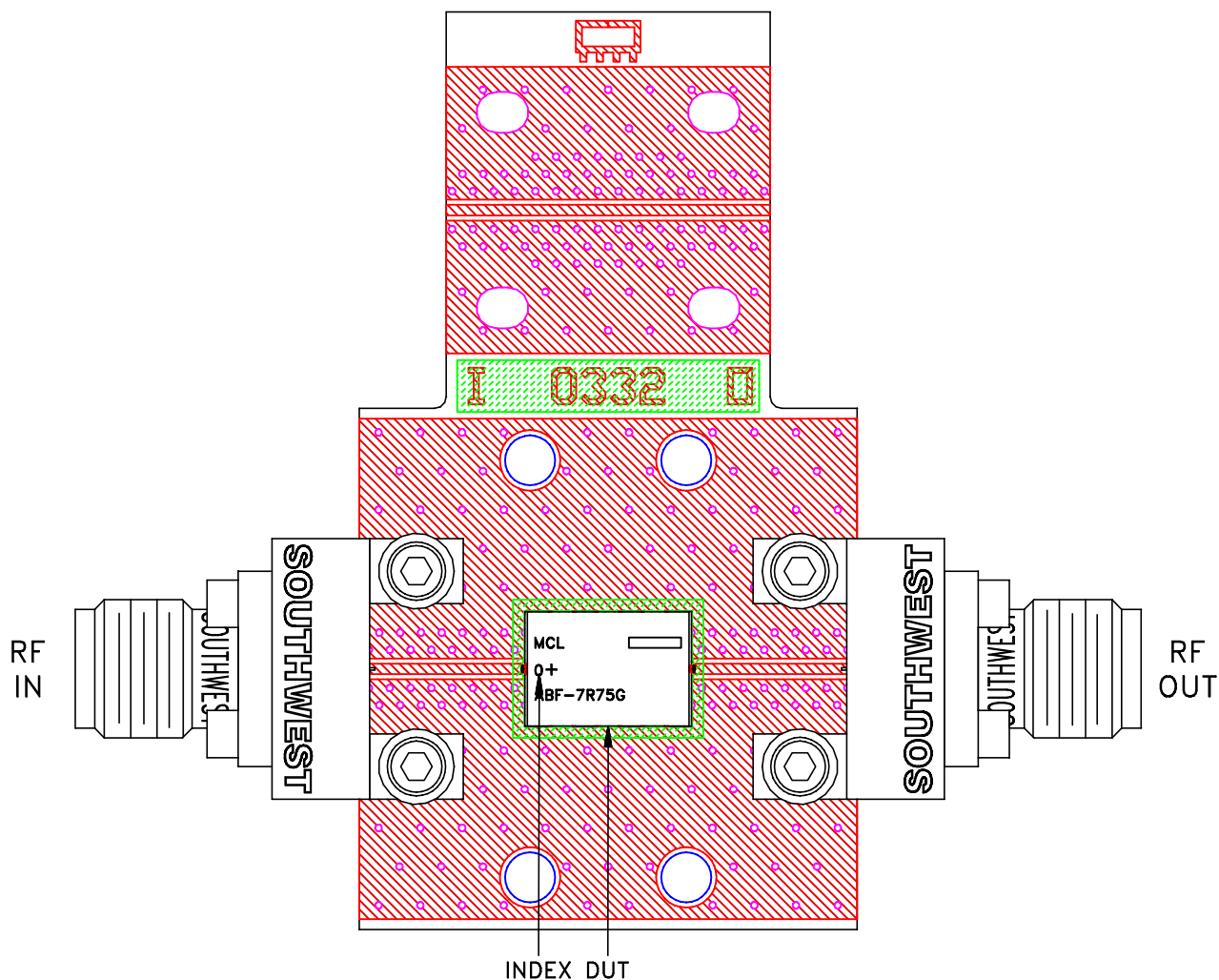


- NOTES:
- COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
-  DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
-  DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

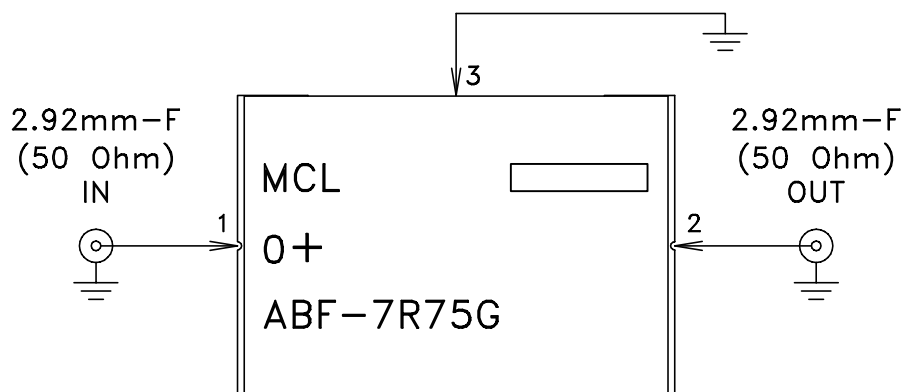
UNLESS OTHERWISE SPECIFIED		INITIALS	DATE	 Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235		
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	DDR	29 MAR 21			
	CHECKED	RR	29 MAR 21			
	APPROVED	NN	29 MAR 21			
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		SIZE	CODE IDENT	DRAWING NO:	REV:	
		A	15542	98-PL-652	A	
		FILE:	98-PL-652	SCALE:	10:1	SHEET: 1 OF 1
ASHEETA1.DWG REV:A DATE:01/12/95						

Evaluation Board and Circuit

TB-ABF-7R75G+




Schematic diagram



Notes:

1. PCB Material: ROGERS (R04350B) OR Equivalent, Dielectric Constant= $3.48 \pm .05$
Dielectric Thickness: $.010 \pm .001$
2. 50 Ohm 2.92mm Female Connectors.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C